



**Pb-free
HEAT**



1211F Series

Bi-color Right Angle Type (3.0 X 2.0 mm)

Features

Package	Bi-Color Type(3.0 x 2.0mm), Milky White resin
Product features	<ul style="list-style-type: none"> • Outer Dimension 3.0 x 2.0 x 1.0mm (L x W x H) • Temperature range Storage Temperature : -40°C~100°C Operating Temperature : -40°C~85°C • No lead package and lead-free soldering compatible • RoHS compliant
Dominant wavelength	Green : 567nm(PG) Yellow Green : 572nm(PY) Yellow : 590nm(AY) Red : 647nm(BR)
Half Intensity Angle	PG : $\theta_x = 150 \text{ deg.}, \theta_y = 140 \text{ deg.}$ PY : $\theta_x = 148 \text{ deg.}, \theta_y = 140 \text{ deg.}$ AY : $\theta_x = 150 \text{ deg.}, \theta_y = 140 \text{ deg.}$ BR : $\theta_x = 149 \text{ deg.}, \theta_y = 143 \text{ deg.}$
Die materials	PG,PY : GaP AY : GaAsP BR : GaAlAs
Rank grouping parameter	Sorted by luminous intensity per rank taping
Assembly method	Auto pick & place machine (Auto Mounter)
Soldering methods	Reflow soldering and manual soldering
Taping and reel	3,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: $\phi 180\text{mm}$
ESD	More than 2kV (HBM)

Recommended Applications

Cellular Phone, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Die Name	Material	Emitted Color	Lens Color	Dominant Wavelength		Luminous Intensity		
					λd (nm)		Iv (mcd)		
					TYP.	I _F	MIN.	TYP.	I _F
AYPG1211F	PG	GaP	Green	Milky White	567	20	3.7	5.2	20
	AY	GaAsP	Yellow		590	20	2.1	3.0	20
BRPY1211F	PY	GaP	Yellow Green	Milky White	572	20	6.2	8.8	20
	BR	GaAlAs	Red		647	20	12.4	17.6	20

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings				Unit
		PG	PY	AY	BR	
Power Dissipation	P_d	70	70	70	70	mW
Forward Current	I_F	25	25	25	25	mA
Pulse Forward Current ※1	I_{FRM}	60	60	60	60	mA
Derating (Ta=25°C or higher)	ΔI_F	0.36	0.36	0.36	0.36	mA/°C
	ΔI_{FRM}	0.86	0.86	0.86	0.86	mA/°C
Reverse Voltage	V_R	4	4	4	4	V
Operating Temperature	T_{opr}	-40~+85				°C
Storage Temperature	T_{stg}	-40~+100				°C

※1 I_{FRM} Measurement condition : Pulse Width ≤ 1 ms., Duty $\leq 1/20$.

The ratings specified above is under the condition that only one diode is lit.

50% Max. of each rating shall be applied when two diodes are lit simultaneously.

Electro-Optical Characteristics

(Ta=25°C)

Item	Conditions	Symbol	Characteristics				Unit	
			PG	PY	AY	BR		
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	2.2	1.7	V
			MAX.	2.8	2.8	2.8	2.3	
Reverse Current	V _R =4V	I _R	MAX.	100	100	100	100	μ A
Peak Wavelength	I _F =20mA	λ _p	TYP.	560	570	580	660	nm
Dominant Wavelength	I _F =20mA	λ _d	TYP.	567	572	590	647	nm
Spectral Line Half Width	I _F =20mA	Δλ	TYP.	30	30	30	30	nm
Half Intensity Angle	I _F =20mA	2θ 1/2	TYP.	150(θ x)	148(θ x)	150(θ x)	149(θ x)	deg.
				140(θ y)	140(θ y)	140(θ y)	143(θ y)	

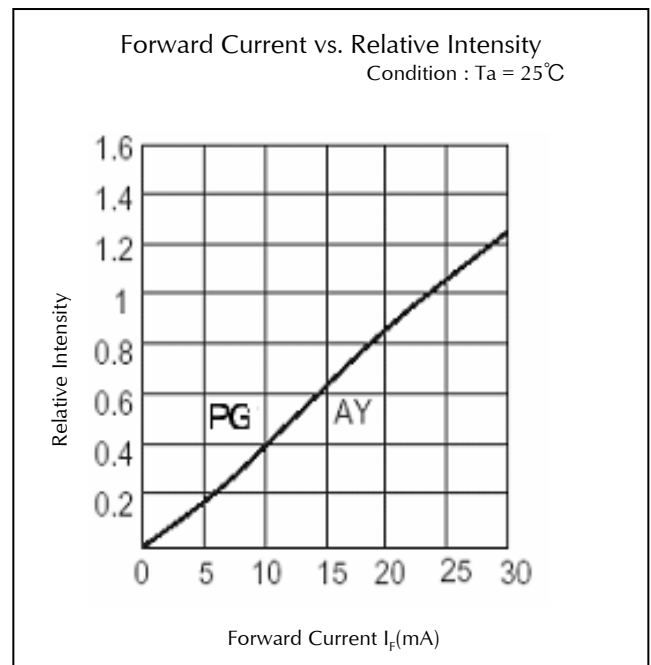
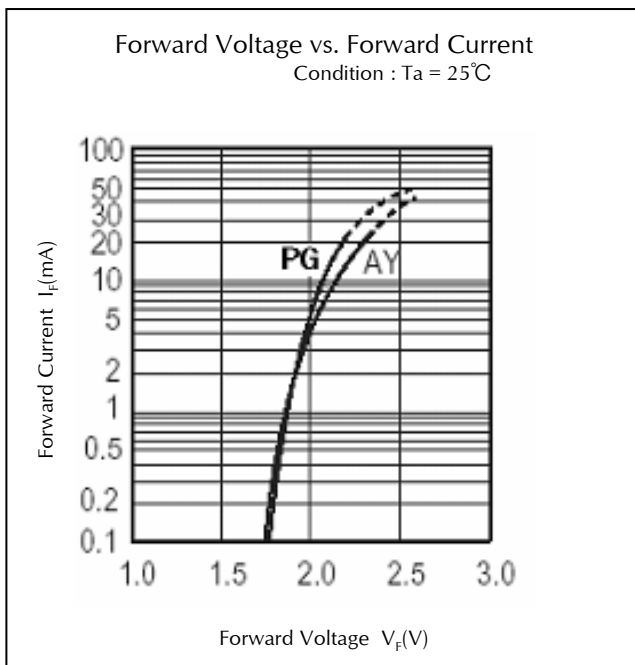
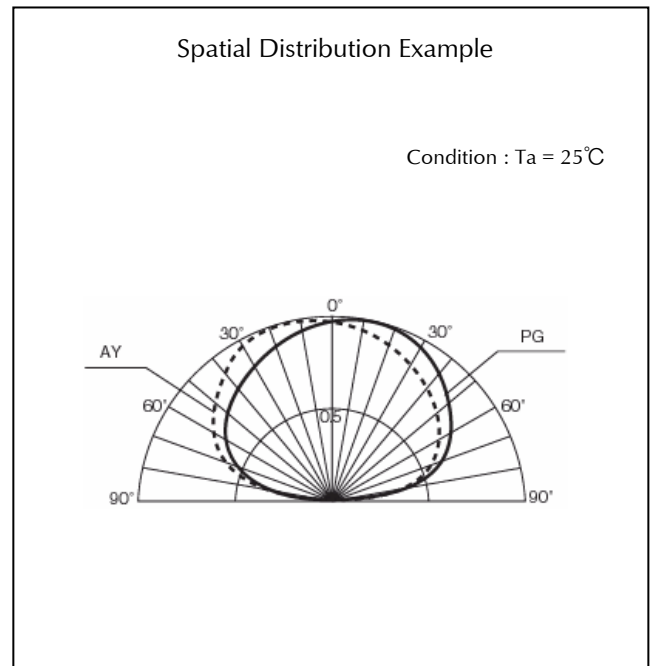
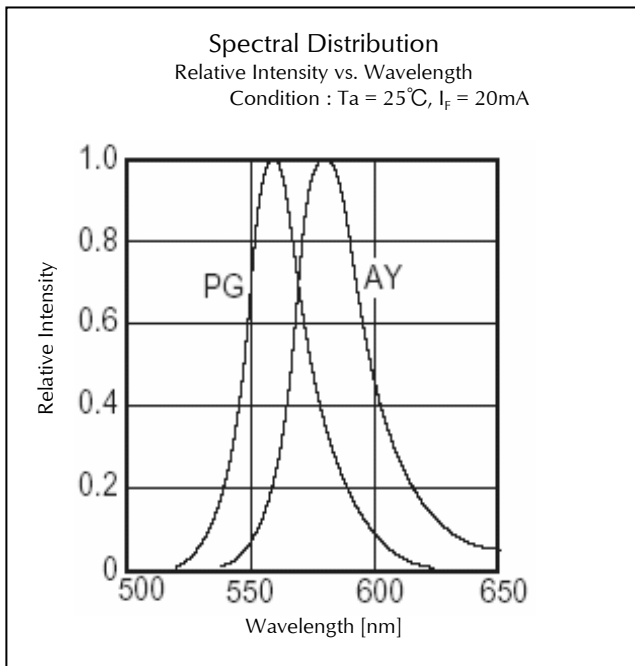
Luminous Intensity Rank

(Ta=25°C)

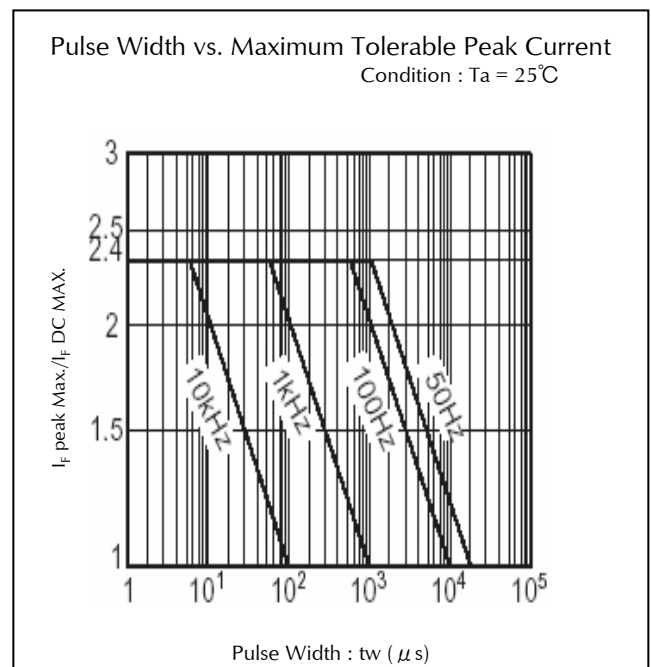
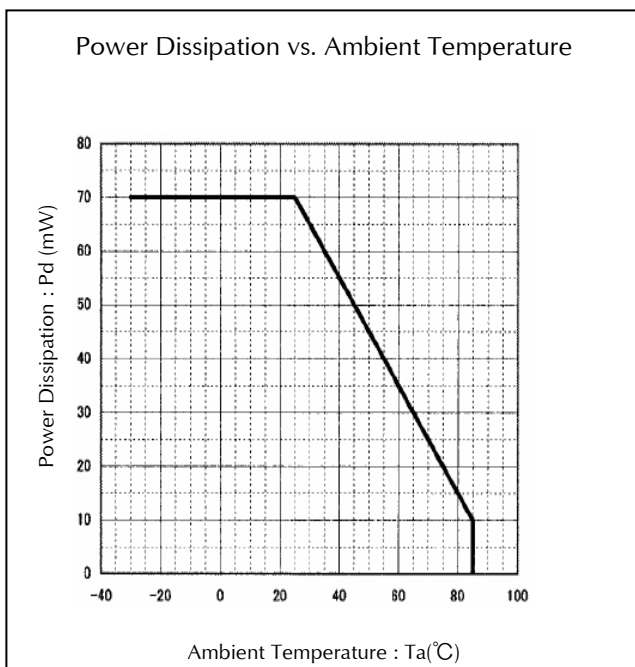
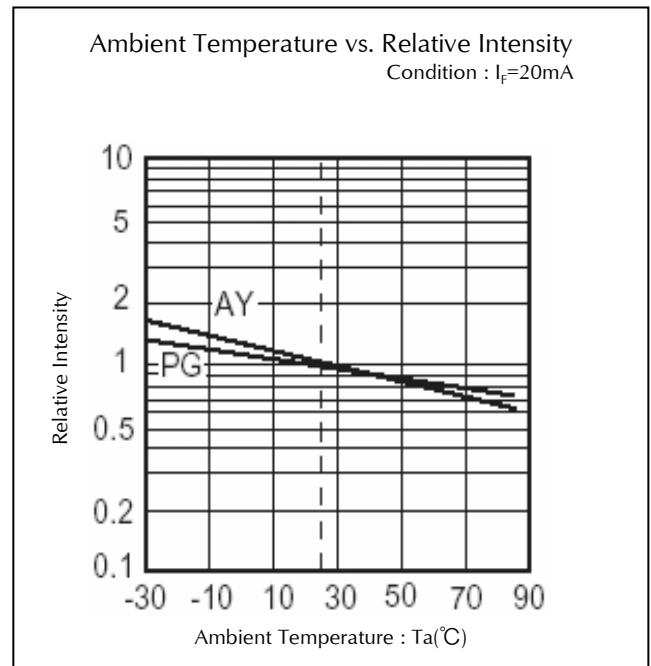
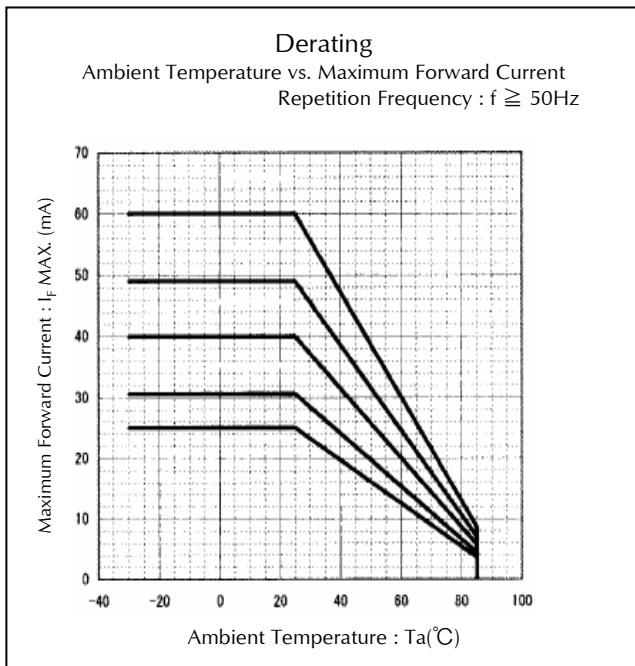
Rank	I _v (mcd)								Condition
	AYPG1211F				BRPY1211F				
	PG		AY		PY		BR		
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
AA	3.7	7.4	2.1	4.2	6.2	12.4	12.4	24.8	I _F = 20mA
AB	5.2	10.4	2.1	4.2	8.8	17.6	12.4	24.8	
AC	7.4	14.8	2.1	4.2	12.4	24.8	12.4	24.8	
BA	3.7	7.4	3.0	6.0	6.2	12.4	17.6	35.2	
BB	5.2	10.4	3.0	6.0	8.8	17.6	17.6	35.2	
BC	7.4	14.8	3.0	6.0	12.4	24.8	17.6	35.2	
CA	3.7	7.4	4.2	8.4	/				
CB	5.2	10.4	4.2	8.4					
CC	7.4	14.8	4.2	8.4					

Please contact our sales staff concerning rank designation.

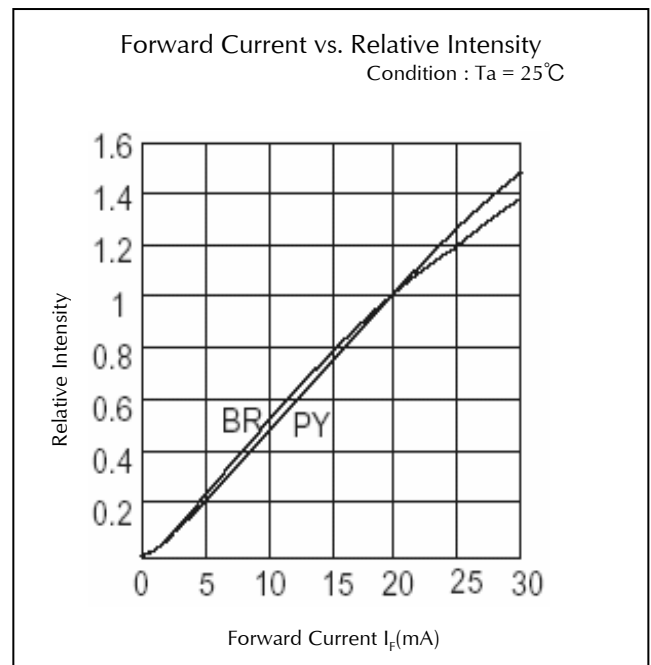
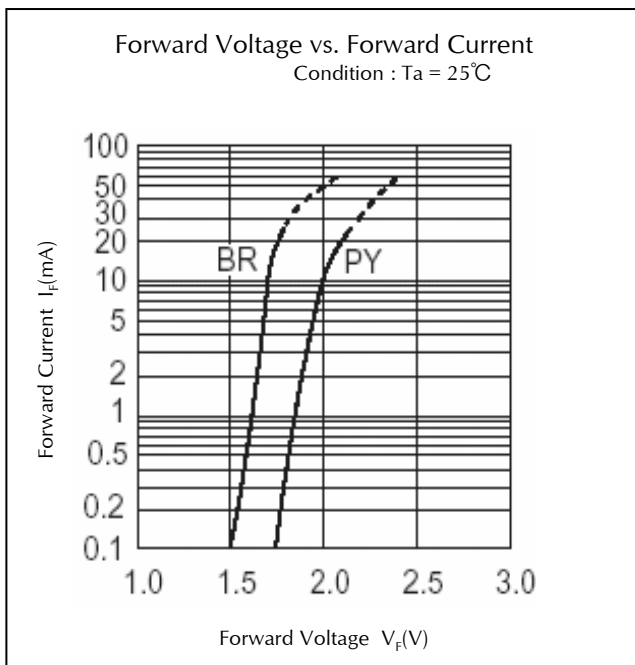
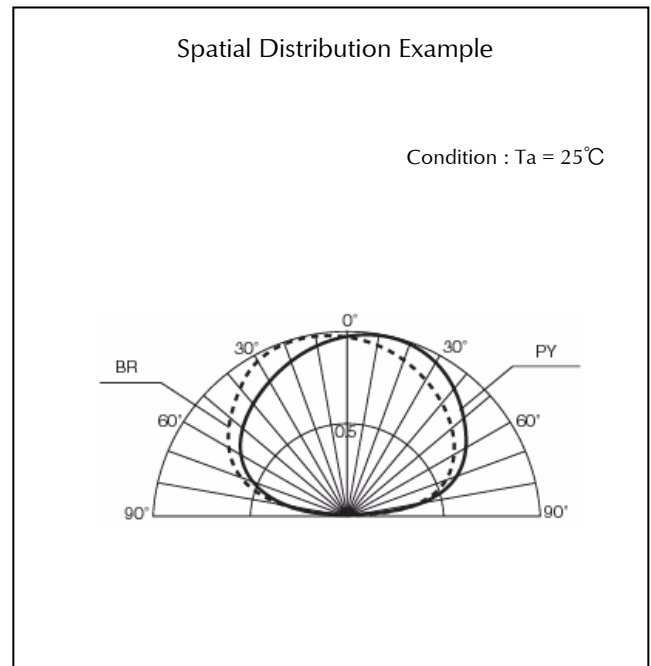
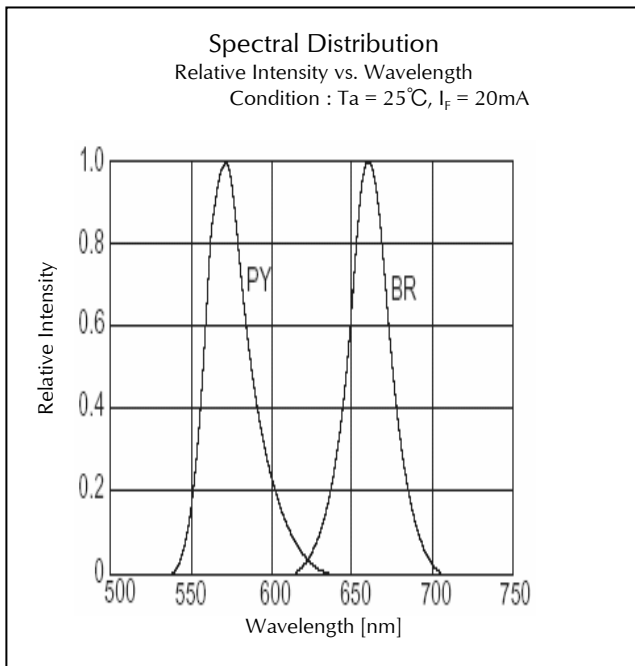
Technical Data(AYPG)



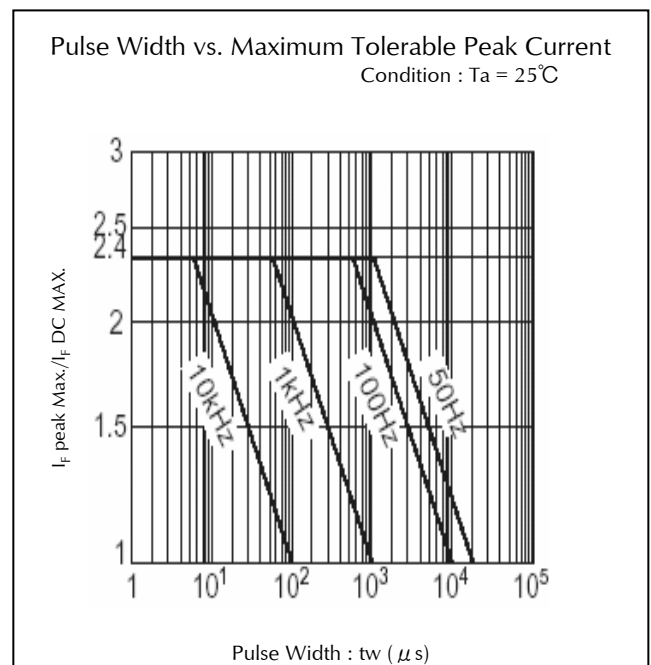
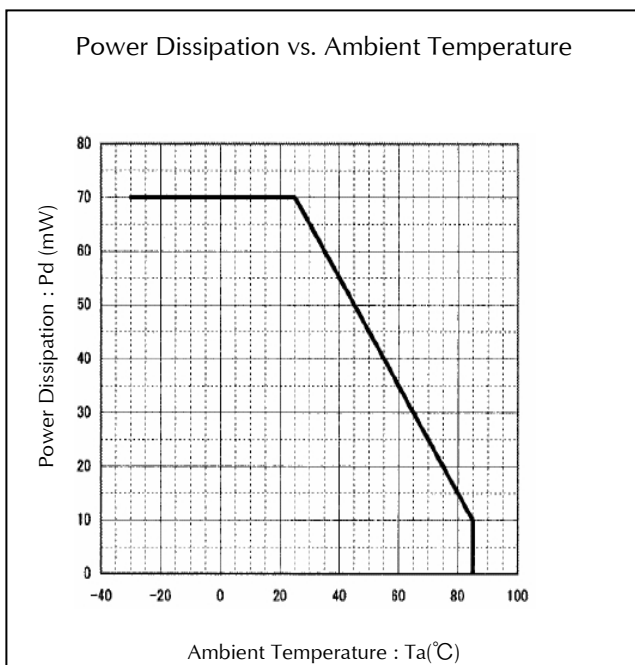
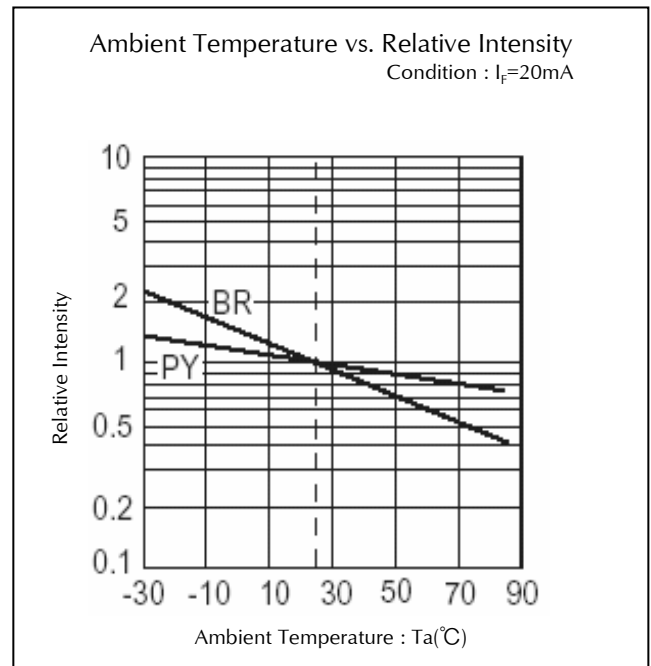
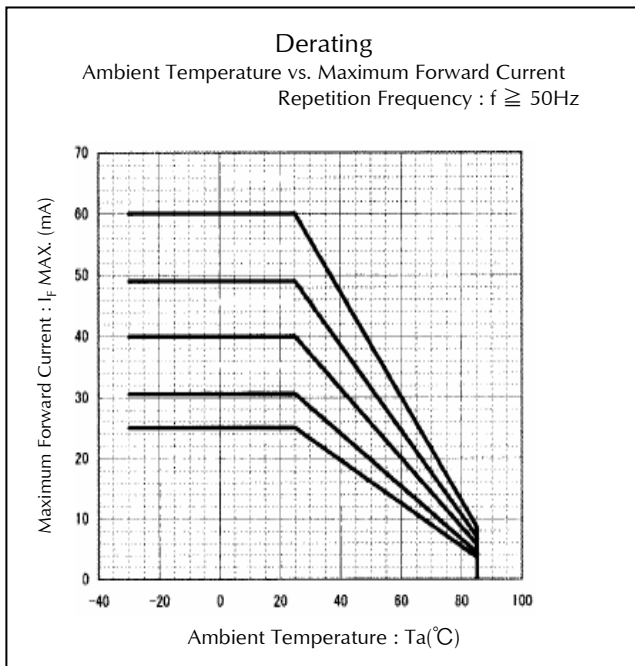
Technical Data(AYPG)



Technical Data(BRPY)



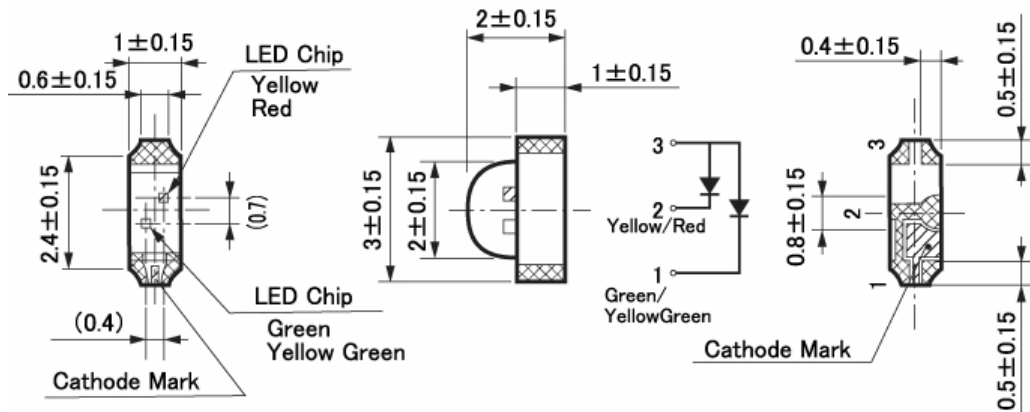
Technical Data(BRPY)



Package Dimensions

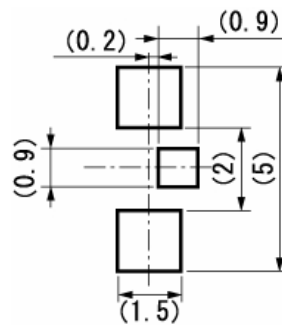
(Unit: mm)

Weight: (8.87)mg



Recommended Soldering Pattern

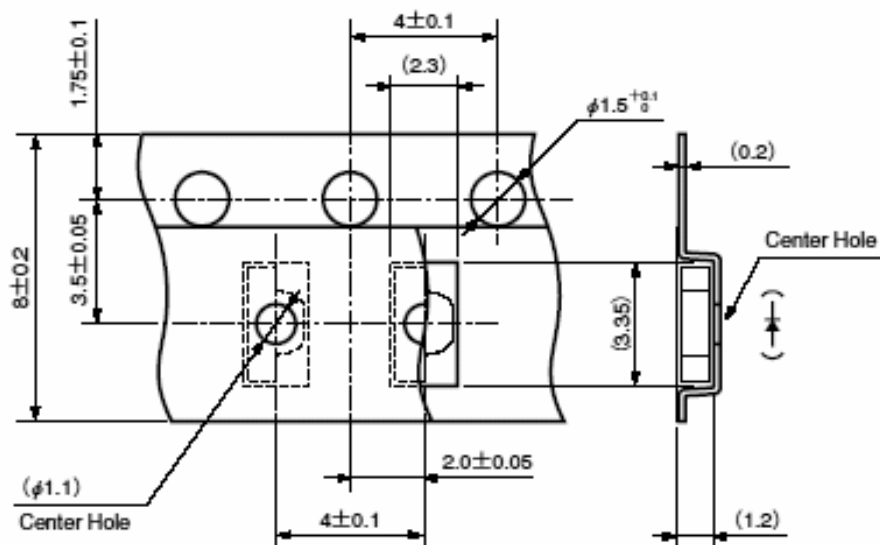
(Unit: mm)



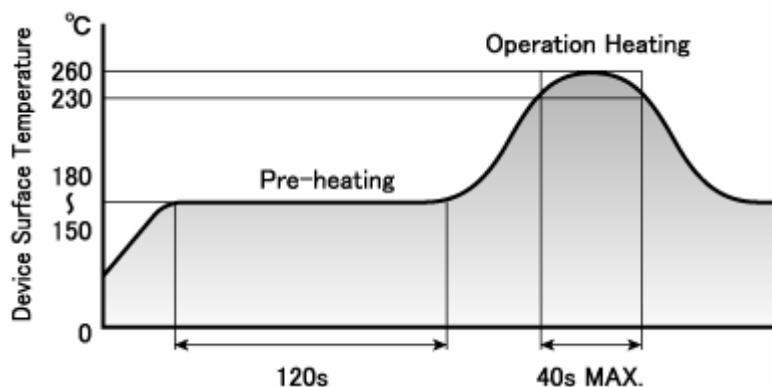
Taping Specification

(Unit: mm)

Quantity : 3,000pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized. (6°C maximum)

Manual Soldering Conditions

Iron tip temp.	350 °C	(MAX.)
Soldering time and frequency	3 s	(MAX.)
	1 time	(MAX.)

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	260±5°C	5sec	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	No notable, decoloration, deformation and cracking

Special Notice to Customers Using the Products and Technical Information Shown in This Data Sheet

- 1) The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.
- 2) For the purpose of product improvement, the specifications, characteristics and technical data described in the data sheets are subject to change without prior notice. Therefore it is recommended that the most updated specifications be used in your design.
- 3) When using the products described in the data sheets, please adhere to the maximum ratings for operating voltage, heat dissipation characteristics, and other precautions for use. We are not responsible for any damage which may occur if these specifications are exceeded.
- 4) The products described in the data sheets are made to be used in standard electronic applications such as office automation appliances, communication devices, audio visual, home appliances, and measuring instruments.
- 5) If the products in the data sheets are to be used for purposes other than the above which requires high level reliability and safety where failure and or malfunction of the product may cause death or other serious effects on the human body such as airplane, space activity, transportation, medical, nuclear), please contact our sales personnel.
- 6) In order to export the products or technologies described in this data sheet which are under the "Foreign Exchange and Foreign Trade Control Law," it is necessary to first obtain an export permit from the Japanese government.
- 7) No part of this data sheet may be reprinted or reproduced without prior written permission from Stanley Electric Co., Ltd.
- 8) The most updated edition of this data sheet can be obtained from the address below:
<http://www.stanley-components.com>